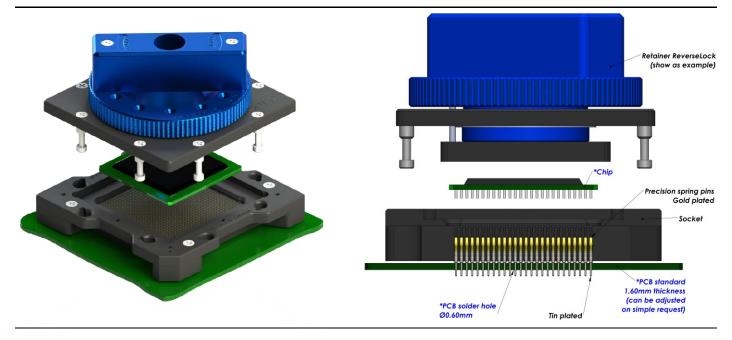
Through-hole (THT) soldering Test Socket

For CGA / PGA / PGI Package

1.27 mm pitch (from 1.27 mm upwards)





E-tec Interconnect AG is the world leading Test socket manufacturer

The Through-hole socket uses the same footprint as your chip. Socket is simply placed and wave soldered onto the PCB in the same way as the chip and it only requires a small amount of additional board space. Through-hole sockets are available with all retention systems. Please note, we will always request the chip data to ensure we offer a compatible socket.

Specifications contact type code 1270			
Application	Through-hole technology	Force	25 gr
Mounting	THT	Current rating	2.2 A
Bandwidth (GHz@-1dB)	3 GHz	Capacitance pF	< 1 pF
Contact resistance	<100mOhm	Inductance nH	< 2 nH
Chip contact tip shape	Single Point tip or Concave tip	Temperature range	-55°C to +150°C
PCB tip shape	Through-hole	Mating cycles	100 K

How to order

